

# NOT RECOMMENDED FOR NEW DESIGN CONTACT US



DMN4031SSD

### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

# **Product Summary**

BVDSS	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C (Note 6)		
40) (	$31m\Omega$ @ V <sub>GS</sub> = $10V$	7.0A		
40V	$50m\Omega$ @ $V_{GS} = 4.5V$	5.8A		

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

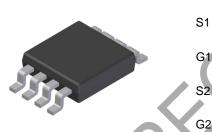
- Motor controls
- Backlighting
- Power management functions
- DC-DC converters

### **Features and Benefits**

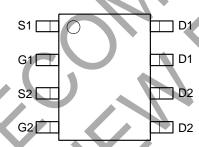
- Low On-Resistance
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
  - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMN4031SSDQ)

### **Mechanical Data**

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.072 grams (Approximate)

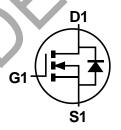




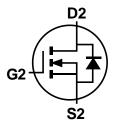


SO-8

Top View



N-Channel MOSFET



N-Channel MOSFET

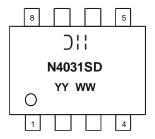
## Ordering Information (Note 4)

Part Number	Package	Packing	
Fait Number	Package	Qty.	Carrier
DMN4031SSD-13	SO-8	2,500	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



⊃¦¦ = Manufacturer's Marking
 N4031SD = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Year (ex: 23 = 2023)
 WW = Week (01 to 53)



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V <sub>DSS</sub>	40	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5) (V <sub>GS</sub> = 10V)	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	5.2 4.1	А
Continuous Drain Current (Note 5) (VGS = 4.5V)	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lο	4.3 3.4	А
Continuous Drain Current (Note 6) (Vgs = 10V)	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lο	7.0 5.6	А
Continuous Drain Current (Note 6) (Vgs = 4.5V)	lο	5.8 4.7	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	40	Α		
Maximum Continuous Body Diode Forward Current	Is	2.2	A		
Pulsed Body Diode Forward Current (10µs Pulse, I	Isм	40	Α		
Avalanche Current, L = 0.1mH (Note 7)	las	11	A		
Avalanche Energy, L = 0.1mH (Note 7)	Eas	18	mJ		

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.42	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	Reja	88	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	2.6	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	Reja	48	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

5. Device mounted on FR-4 PCB, with minimum recommended pad layout. The value in any given application depends on user's specific board design. 6. Device mounted on 1" x 1" FR-4PCB with high coverage 1 oz. copper, single sided.

7. IAS and EAS ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.





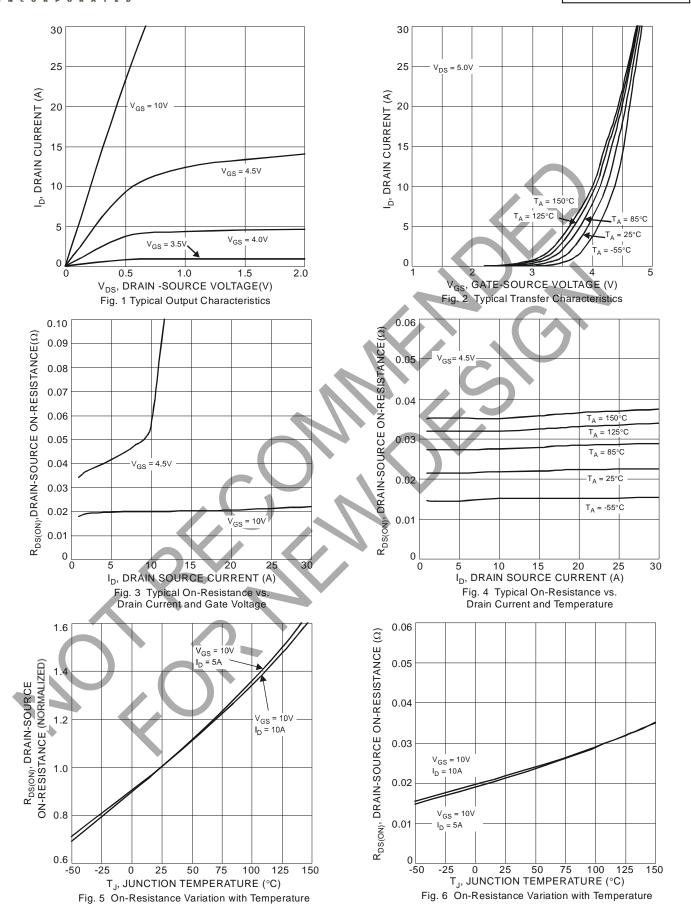
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40		_	V	$V_{GS} = 0V$ , $I_D = 10mA$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 40V$ , $V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	VGS(TH)	1.6	2.4	3.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
On-State Drain Current	I <sub>D</sub> (ON)	20	_	_	Α	Vgs = 10V, Vps = 5A
Chatia Brain Course On Benistance		_	19	31	0	$V_{GS} = 10V, I_D = 6A$
Static Drain-Source On-Resistance	RDS(ON)	_	44	50	mΩ	$V_{GS} = 4.5V, I_D = 5A$
Forward Transfer Admittance	Y <sub>FS</sub>		11	_	S	$V_{DS} = 5V$ , $I_{D} = 6A$
Diode Forward Voltage	$V_{SD}$	_	0.74	1.0	V	$V_{GS} = 0V$ , $I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	945	_	pF	\( \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Output Capacitance	Coss	_	69	_	рF	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	58		pF	T = T.OIVINIZ
Gate Resistance	Rg		1.45	1	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	8.4		nC	
Total Gate Charge (Vgs = 10V)	Qg	_	18.6	_	nC	$V_{GS} = 10V, V_{DS} = 20V,$
Gate-Source Charge	Qgs	_	3.3		nC	ID = 12A
Gate-Drain Charge	Qgd	+	2.2	_	nC	
Turn-On Delay Time	t <sub>D</sub> (ON)	_//	6.4	_	ns	
Turn-On Rise Time	tR	-1	9.7	-(	ns	VGS = 10V, VDS = 20V,
Turn-Off Delay Time	tD(OFF)	-	19.8	/_	ns	$R_L = 1.6\Omega$ , $R_G = 3\Omega$
Turn-Off Fall Time	t <sub>F</sub>		3.1	<b>→</b>	ns	

8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing. Notes:









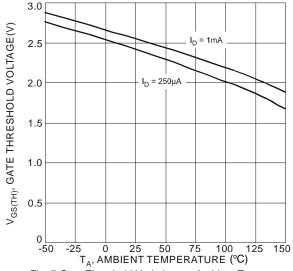
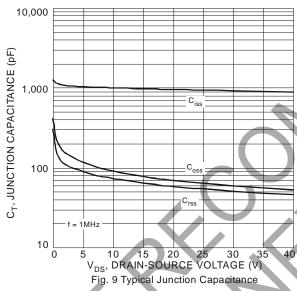
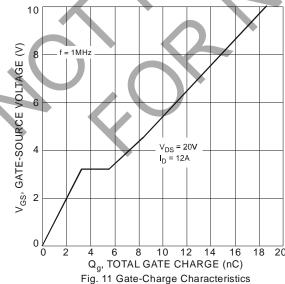
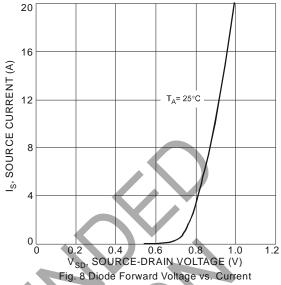


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







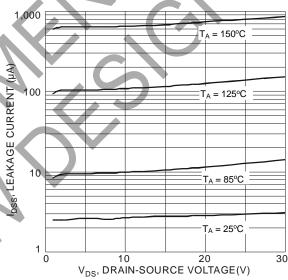
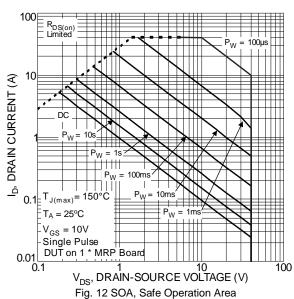
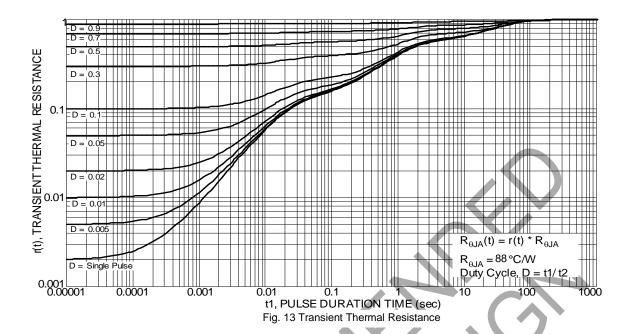


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage





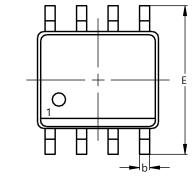


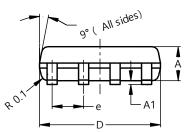


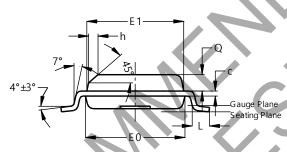
# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

**SO-8** 



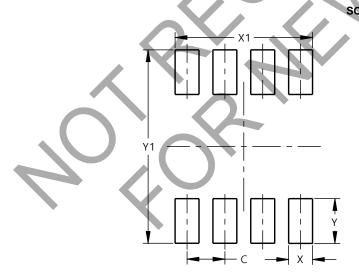




SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D 4	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
Ē	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
Φ	-	_	1.27		
h	-	_	0.35		
L	0.62	0.82	0.72		
ø	0.60	0.70	0.65		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			



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